

THE 4th IIW YOUNG PROFESSIONALS INTERNATIONAL CONFERENCE YPIC2018

29 | 30 | 31 AUGUST 2018

Hosted by Institut de Soudure And,

Supported by the International Institute of Welding

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CONFERENCE GOAL

IIW YPIC aims at gathering worldwide students and young professionals who are specializing in welding and related technologies. The main goal is to raise awareness of industrial issues by providing a forum for networking, for sharing and harmonizing ideas.

This event aims to integrate and mediate professional knowledge in the fields of welding and related technologies and non-destructive testing. It is an opportunity for young researchers and professionals to share and exchange results.

Event's highlights:

- Speed dating ice breaking
- Conference with oral presentations
- Team Building
- Networking events

CONFERENCE TOPICS:

- Welding technology and related technologies
- Non-destructive testing
- 3D Printing and additive manufacturing
- Industrial unmanned aerial vehicle and objects connected

There is no restriction in categories and ages of participants. Professors and industrial representatives are welcome as well

The conference includes an exhibition designed as a platform to facilitate contact between young professionals and companies.

CALL FOR PAPERS

Authors wishing to present a contribution are kindly requested to submit an abstract in English (500 words max.) including title, author names, affiliation, and complete correspondence information of the lead author.

Word templates are available on the website of the conference. All submissions must be made online.

Please submit your paper by 30 April 2018 to ypic2018@isgroupe.com. Authors will be notified of acceptance of their paper in May 2018.

The presentation delivered in English must be no longer than 15 minutes. After presentation discussion will be open for about 5 minutes

REGISTRATION FEES – Tax. Inclu

Information about registration, transportation and hotel accommodations will be available on the website www.ypic2018.com

Students* 120 euros
Young Professionals** 240 euros
Others 360 euros
Tax. Inclu

- * student card necessary
- ** 5 years after leaving university





The registration fee includes: admission to scientific sessions, abstract book, coffee breaks, two lunches, two dinners and gala dinner.

You are kindly asked to use the online registration.

CONTACT

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Exhibition and partnership deals for YPIC 2018

Are you interested to get in interaction to young professionals? We would be pleased to inform you about our sponsoring packages. If you are interested, please do not hesitate to contact the project leader at ypic2018@isgroupe.com.

Be a Partner: €1000 EXCL. VAT

- Raise awareness Young Professionals to industrial issues by proposing a real case to solve during Team Building
- Possibility to make a non-commercial presentation
- Pre-fitted 6m² stand comprising structure, partitions, sign, spotlights + electric box (3 kWh) with daily cleaning of the stand
- Your logo on communication media (pre-event advertisements and YPIC 2018 book abstracts)
- Your logo on www.ypic2018.com homepage
- Your logo on signs during the congress
- Your brochure (to be provided by you) inserted into the bags given out to young professionals
- One advertising page (to be provided by you) in the YPIC 2018 book abstracts handed out to all participants
- Two open passes (access to conferences with simultaneous interpreting, coffee break and lunches throughout the event, gala dinner)

Be an Actor: €500 EXCL. VAT

- Stand installation: structure, partitions, sign, spotlights + electric box (3 kWh)
- Daily cleaning of the stand
- Registration in the official catalogue and on the exhibitor list on www.ypic2018.com
- A copy of the YPIC2018 book abstracts
- One open pass (access to conferences with simultaneous interpreting, coffee break and lunches throughout the event, gala dinner)



